

# Hyperfast Soft Recovery Diode, 60 A FRED Pt<sup>®</sup> Gen 4



PRODUCT SUMMARY					
Package	TO-247AD 2L				
I <sub>F(AV)</sub>	60 A				
$V_{R}$	600 V				
V <sub>F</sub> at I <sub>F</sub>	1.48 V				
t <sub>rr</sub> typ.	see Recovery table				
T <sub>J</sub> max.	175 °C				
Diode variation	Single die				

#### **FEATURES**

- Gen 4 FRED Pt® technology
- Low I<sub>RRM</sub> and reverse recovery charge
- · Very low forward voltage drop
- Polyimide passivated chip for high reliability standard
- 175 °C operating junction temperature
- AEC-Q101 qualified, meets JESD 201 class 1 whisker test
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>





HALOGEN

**FREE** 

## DESCRIPTION

Gen 4 Fred technology, state of the art, ultralow  $V_F$ , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimized the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Cathode to anode voltage	$V_R$		600	V		
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 106 °C	60	۸		
Single pulse forward current	I <sub>FSM</sub>	$T_C = 25$ °C, $t_p = 8.3$ ms, half sine wave	425	А		
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C		

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	DL TEST CONDITIONS MIN.		TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	$V_{BR}, V_{R}$	I <sub>R</sub> = 100 μA	600	-	-			
		I <sub>F</sub> = 50 A	-	1.68	-	V		
	V <sub>F</sub>	I <sub>F</sub> = 60 A	-	1.75	2.0			
Forward voltage		I <sub>F</sub> = 50 A, T <sub>J</sub> = 125 °C	-	1.44	-			
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 125 °C	-	1.55	-			
		I <sub>F</sub> = 50 A, T <sub>J</sub> = 150 °C	-	1.39	-			
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 150 °C	-	1.48	1.65			
Deviates legises surrent	I <sub>R</sub>	V <sub>R</sub> = V <sub>R</sub> rated	-	-	50			
Reverse leakage current		T <sub>J</sub> = 125 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	-	500	μA		
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 600 V	-	30	-	pF		



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	SYMBOL TEST CONDITIONS				MAX.	UNITS	
Povorco rocovony timo	+	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 60 A dI <sub>F</sub> /dt = 1000 A/μs V <sub>R</sub> = 400 V	1	68	1	ns	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	92	-		
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	20	-	А	
		T <sub>J</sub> = 125 °C		-	40	-		
Reverse recovery charge	0	T <sub>J</sub> = 25 °C		-	945	-	nC	
	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	2500	-	nC	

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	0.6	°C/W		
Thermal resistance, case to heat sink	R <sub>thCS</sub>	Mounting surface, flat, smooth and greased	-	0.25	-			
NA/a:alat			-	6.0	-	g		
Weight			ı	0.21	-	oz.		
Mounting torque			6.0		12	kgf · cm		
Mounting torque			(5)	_	(20)	(lbf $\cdot$ in)		
Marking device		Case style TO-247AD 2L	E4PH6006LH					

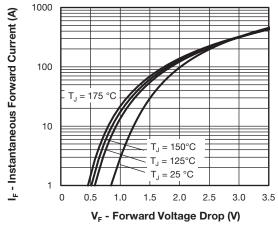


Fig. 1 - Typical Forward Voltage Drop Characteristics

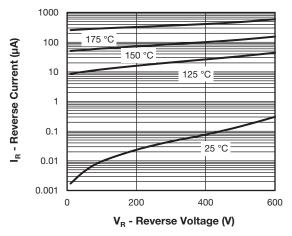


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

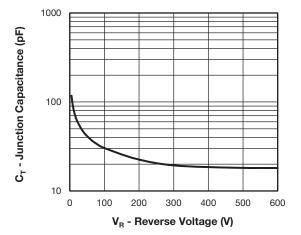


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

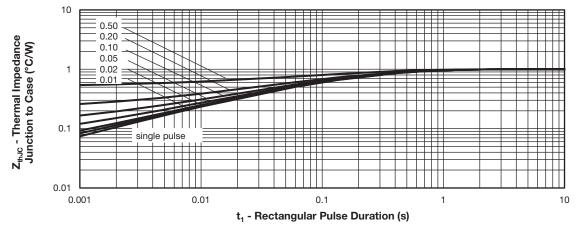


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

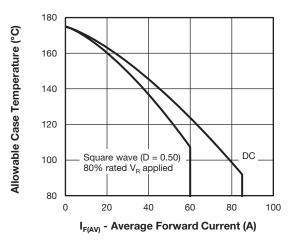


Fig. 5 - Max. Allowable Case Temperature vs. Average Forward Current

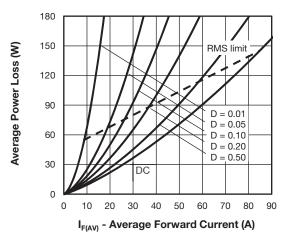


Fig. 6 - Forward Power Loss Characteristics

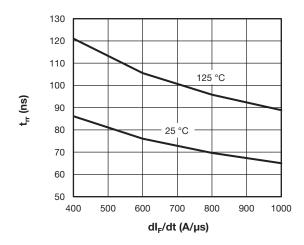


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_{\text{F}}/dt$ 

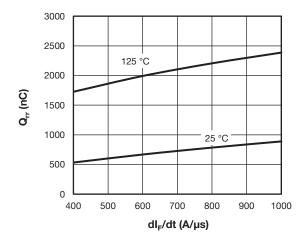


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

### Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}; \\ Pd = \text{Forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see Fig.5)} \\ P_{dREV} = \text{Inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_R = \text{rated } V_R \\ \end{array}$ 

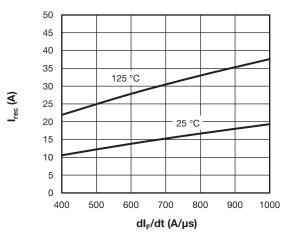
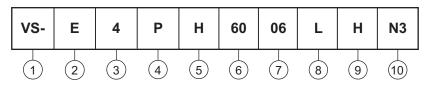


Fig. 9 - Typical Reverse Recovery vs. dl<sub>F</sub>/dt

#### **ORDERING INFORMATION TABLE**

#### Device code



- 1 Vishay Semiconductors product
- Circuit configuration:E = single diode 2 pins
- 3 FRED Gen 4
- 4 P = TO-247 package
- **5** Process type:

H = Hyperfast recovery

- 6 Current rating (60 = 60 A)
- 7 Voltage rating (06 = 600 V)
- 8 L = long lead
- 9 H = AEC-Q101 qualified
- Environmental digit:

N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N QUANTITY PER TUBE MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION							
VS-E4PH6006LHN3	25	500	Antistatic plastic tube				

LINKS TO RELATED DOCUMENTS					
Dimensions TO-247AD 2L <u>www.vishay.com/doc?95536</u>					
Part marking information	TO-247AD 2L	www.vishay.com/doc?95648			

### **TO-247AD 2L**

### **DIMENSIONS** in millimeters and inches



View B

SYMBOL	MILLIN	IETERS	INCHES		NOTES
SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4
D2	0.51	1.35	0.020	0.053	

Section C - C, D - D

SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Е	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØK	0.2	254	0.0	0.010	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
	•		•	•	

#### **Notes**

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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